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Ceramic Capacit	ors			
Fixed Ceramic Capa	citors			
Part Number : C2012X7	R1H104K/1.25			
Product Name :				
Multilayer Ceramic Chip Ca	apacitors - Ger	neral Purpose		
Wiew Datasheet				
*	eries			
Application : Electronics equipment, automation equipment, Charge pump, etc. Mobile communications equipment, Office Automotive electronics, Test and Hybrid ICs, Decoupling, Smoothing, Charge pump, etc.				
Function :				
It has no polarity. High reli for various circuit such as through.				
Description : Small Size General Capaci It has no polarity. High reli				
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Application	Catalog	SEAT CCV	/ TVCL	Tech Notes
Pror	erty Name		Property Description	
Product Lifecycle Stage		Production		
Part Number Replacement		No Data Available.		
Lead (Pb) Free		Yes		
Surface Mount		Yes		
EIA Size Code		0805		
Size Code		2012		
Body Length (L)		Min 1.8 mm		
Body Length (L)		Nom 2 mm		
Body Length (L)		Max 2.2 mm		
Body Breadth (W)		Max 2.2 mm		
Body Breadth (W)		Nom 1.25 mm		
		Max 1.45 mm		
Body Breadth (W)		Max 1.45 mm		
Body Height (T)				
Body Height (T)		Nom 1.25 mm Max 1.45 mm		
Body Height (T) Terminal Width (B)		Max 1.45 mm		
Terminal Spacing (G)		Min 0.2 mm		
Temperature Characteristics		X7R		
Temperature Characteristic	5	Min -15 %		
		Max 15 %		
Category Temperature Rang	10	Min -55 C		
	j 0	Max 125 C		
Rated Voltage Code		1H		
Rated Voltage		Max 50 V		
Rated Voltage Classification		DC		
Withstanding Voltage		Nom 125 V		
Withstanding Voltage Class		DC		
Rated Capacitance		Nom 100000 pF		
Rated Capacitance Capacitance Tolerance Cod	e	Nom 100000 pF		
Capacitance Tolerance Cod Capacitance Tolerance (Val		K Min No Data Availab	le	
Capacitance rolerance (val	,	Min No Data Availad Max No Data Availad		
Capacitance Tolerance (%)		Min -10 %		
Capacitance i dierance (%)		Min - 10 % Max 10 %		
Q		Max 10 %	le.	
∝ Measurement Frequency of	Q	Nom No Data Availad		
Insulation Resistance	~	Min 5000 MOhm		
Dissipation Factor		Max No Data Availa	ble.	
Frequency of Dissipation Fa	ctor	Nom 1 kHz		
Soldering Method		Flow, Reflow, Manua	al	
Storage Temperature Range	9	Min 5 Cel		
		Max 40 Cel		
Packing		Blister (Plastic)Tapi	ng [180mm Reel]	
Minimum Package Qty		Nom 2000 Pcs		
Minimum Order Qty		Nom 2000 Pcs		
Return Status		STD		
		310		
reflects an overview of the pro- information, please refer to TC warranted to meet any specifi in TDK's general product spec	duct characteris DK's general product spe cations of any intermedia ification. Note also that t for use in , or permitted	e purposes only and is subject to change b stics/performance for the particular part nu cification. Please note tha ate or end user different from or in addition his standard part has not been specially d to be resold for, specialized applications s ectively, "Excluded Applications").	mber. For product specification at this standard part is not designed of to the spec lesigned or manufactured for,	or ffications set fort